1 2 3 4 5 6 7 8	Michael J. Bettinger (SBN 122196) mbettinger@sidley.com Irene Yang (SBN 245464) irene.yang@sidley.com SIDLEY AUSTIN LLP 555 California Street, Suite 2000 San Francisco, California 94104 (415) 772-1200 – Telephone (415) 772-7400 – Facsimile Attorneys for Huawei Technologies Co., Ltd., Huawei Device USA, Inc., Huawei Technologies USA, Inc., and HiSilicon Technologies Co. Ltd.	David T. Pritikin (<i>Pro Hac Vice</i>) dpritikin@sidley.com David C. Giardina (<i>Pro Hac Vice</i>) dgiardina@sidley.com Douglas I. Lewis (<i>Pro Hac Vice</i>) dilewis@sidley.com John W. McBride (<i>Pro Hac Vice</i>) jwmcbride@sidley.com SIDLEY AUSTIN LLP One South Dearborn Chicago, Illinois 60603 s (312) 853-7000 – Telephone (312) 853-7036 – Facsimile
9	UNITED STATES DISTRICT COURT	
10	NORTHERN DISTRICT OF CALIFORNIA	
11	SAN FRANCISCO DIVISION	
12	HUAWEI TECHNOLOGIES CO., LTD., HUAWEI DEVICE USA, INC., and	Case Number: 3:16-cv-2787-WHO
13	HUAWEI TECHNOLOGIES USA, INC.,	HUAWEI'S UPDATED ELECTION OF ASSERTED CLAIMS AND ACCUSED
14	Plaintiff(s)/Counterclaim) Defendants,	PRODUCTS PURSUANT TO THE COURT'S CASE MANAGEMENT
15	vs.)	ORDERS
16	SAMSUNG ELECTRONICS CO., LTD,	
17	SAMSUNG ELECTRONICS AMERICA,) INC.,	
18	Defendants / Counterclaim-	
19	Plaintiffs,	
20	and)	
21	SAMSUNG RESEARCH AMERICA, INC.,	
22	Defendant,	
23	v.)	
24	HISILICON TECHNOLOGIES CO., LTD.,	
25	Counterclaim-Defendant.	
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1	Pursuant to the Court's Civil Pretrial Order (Dkt. 208) and the parties' Joint Case Managemen		
2	Conference Statement of January 12, 2018 (Dkt. 224 at 2), Plaintiffs' Huawei Technologies Co., Ltd		
3	Huawei Device USA, Inc., Huawei Technologies USA, Inc., and HiSilicon Technologies Co. Ltd		
4	("Huawei") hereby narrows its currently asserted patent claims to 5, and narrows the accuse		
5	Samsung products to 15 models.		
6	Asserted Claims		
7	• U.S. Patent 8,416,892, claim 10		
8	• U.S. Patent 8,644,239, claims 7, 18		
9	• U.S. Patent 8,885,587, claim 9		
10	• U.S. Patent 8,724,613, claim 5		
11	Accused Products		
12	In accordance with the agreed product narrowing protocol outlined in Dkt. 224, Huawei identified		
13	the following 15 Samsung models.		
14	1. Group 1: Qualcomm MSM 8998 baseband chip		
15	a. Galaxy S8 - SM-G950U		
16	b. Galaxy S8 Plus - SM-G955U		
17	2. Group 2: Qualcomm MSM 8996 baseband chip		
18	a. Galaxy S7 - SM-G930A, G930V, and G930T		
19	b. Galaxy S7 Edge - SM-G935A, G935V, and G935T		
20	3. Group 3: Qualcomm MDM 9635M baseband chip		
21	a. Galaxy S6 - SM-G920V		
22	b. Galaxy Note 5 – SM-N920V		
23	4. Group 4: Qualcomm MSM8974 baseband chip		
24	a. Galaxy S5 - SM-G900A, G900V, and G900T		
25	5. Group 5: Samsung Shannon 333 baseband chip		
26	a. Galaxy S6 – SM-G920A		
27	b. Galaxy Note 5 - SM-N920T		
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1	Dated: October 19, 2018	Respectfully submitted,
2 3		/s/ Michael J. Bettinger Michael J. Bettinger (SBN 122196)
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7		Attorneys for Huawei Technologies Co., Ltd., Huawei Device USA, Inc., Huawei
8		Technologies USA, Inc., and HiSilicon Technologies Co. Ltd.
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